Vishay Siliconix

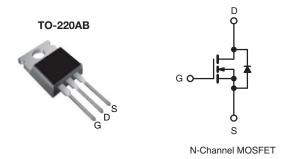
COMPLIANT

HALOGEN

FREE

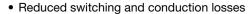
E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.158				
Q _g max. (nC)	95				
Q _{gs} (nC)	16				
Q _{gd} (nC)	25				
Configuration	Single				



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP23N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600		
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	23	A	
		T _C = 100 °C		15		
Pulsed Drain Current a			I _{DM}	63		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	353	mJ	
Maximum Power Dissipation			P_{D}	227	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Orain-Source Voltage Slope T _J = 125 °C		dV/dt	37	- V/ns		
Reverse Diode dV/dt ^d			34			
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



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THERMAL RESISTACNE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.55	G/ VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
0.1.0	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage			$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zara Cata Valtaga Prain Current	,	V _{DS} =	= 600 V, V _{GS} = 0 V		=.	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.132	0.158	Ω
Forward Transconductance	9 _{fs}	V_{DS}	= 30 V, I _D = 12 A	-	6.4	-	S
Dynamic		•			•	•	
Input Capacitance	C _{iss}		V _{GS} = 0 V,		2418	-	
Output Capacitance	C _{oss}	7	$V_{DS} = 100 \text{ V},$	-	119	-	
Reverse Transfer Capacitance	C _{rss}	7	f = 1 MHz		4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V 0VV 400V V 0V		-	107	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	V _{DS} = 0 V	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		320	-	
Total Gate Charge	Q _g		V _{GS} = 10 V I _D = 12 A, V _{DS} = 480 V		63	95	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			16	-	
Gate-Drain Charge	Q _{gd}				25	-	
Turn-On Delay Time	t _{d(on)}		$V_{DD} = 480 \text{ V}, I_{D} = 12 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		22	44	ns
Rise Time	t _r	V _{DD} =			38	76	
Turn-Off Delay Time	t _{d(off)}				66	99	
Fall Time	t _f	7			34	68	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.73	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	
Pulsed Diode Forward Current	I _{SM}			-	-	63	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C, I}_F = I_S = 12 \text{ A,}$ $dI/dt = 100 \text{ A/µs, V}_R = 25 \text{ V}$		-	384	768	ns
Reverse Recovery Charge	Q _{rr}			-	6.4	12.8	μC
Reverse Recovery Current	I _{RRM}			-	30	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

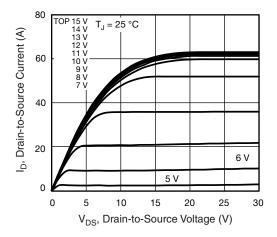


Fig. 1 - Typical Output Characteristics

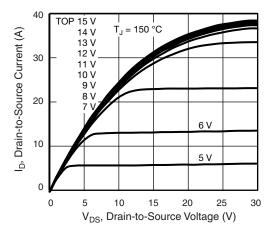


Fig. 2 - Typical Output Characteristics

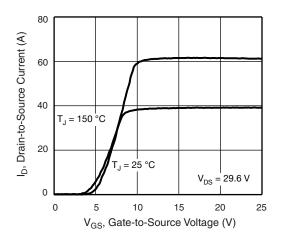


Fig. 3 - Typical Transfer Characteristics

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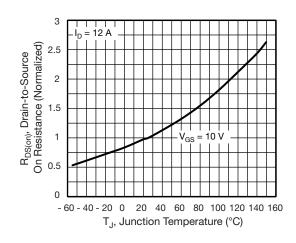


Fig. 4 - Normalized On-Resistance vs. Temperature

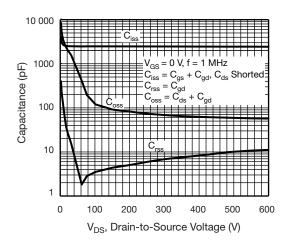


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

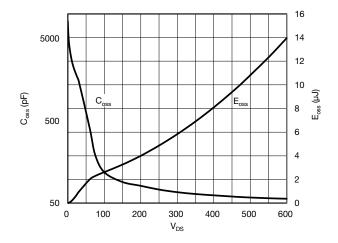


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



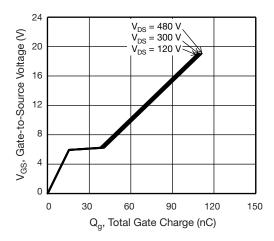


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

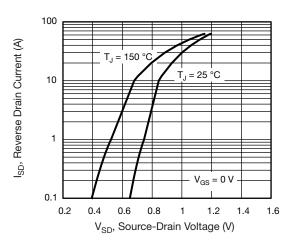


Fig. 8 - Typical Source-Drain Diode Forward Voltage

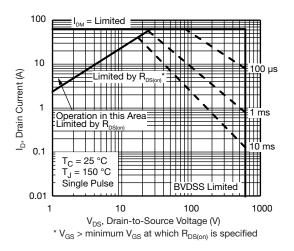


Fig. 9 - Maximum Safe Operating Area

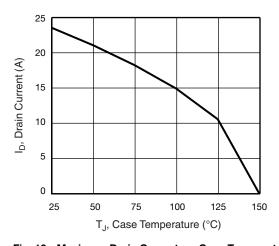


Fig. 10 - Maximum Drain Current vs. Case Temperature

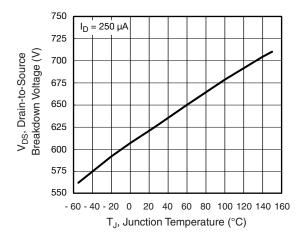


Fig. 11 - Temperature vs. Drain-to-Source Voltage



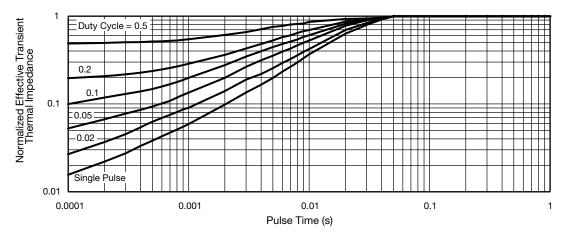


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

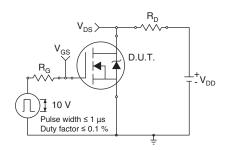


Fig. 13 - Switching Time Test Circuit

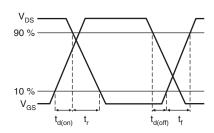


Fig. 14 - Switching Time Waveforms

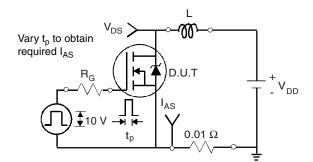


Fig. 15 - Unclamped Inductive Test Circuit

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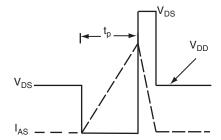


Fig. 16 - Unclamped Inductive Waveforms

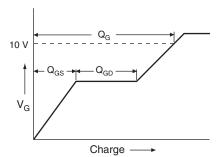


Fig. 17 - Basic Gate Charge Waveform

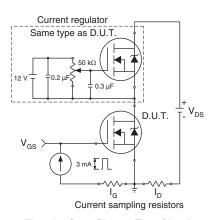
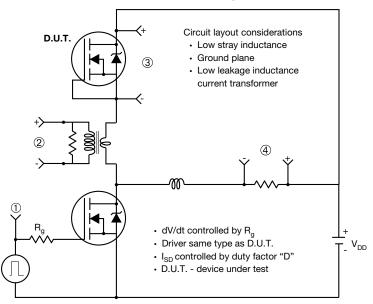


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



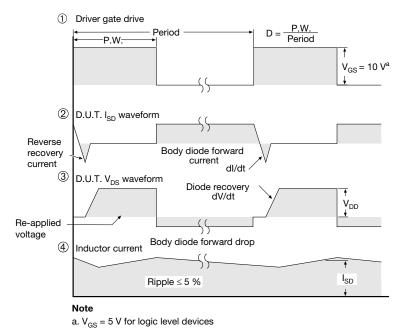
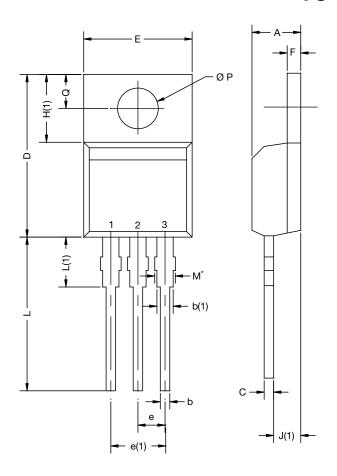


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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